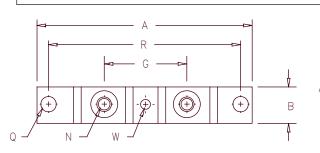
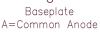
Schottky PowerMod













Notes: Baseplate: Nickel plated copper

Dim. Inches		Millimeters		
Min.	Max.	Min.	Max.	Notes
B 0.700 C E 0.120 F 0.490 G 1.375 H 0.050 N Q 0.275 R 3.15 U 0.600 V 0.312	0.510 BSC 0.290 0 BSC 	12.45 34.92 1.25 6.99 80.0 15.24 7.92	7.37 1 BSC 8.64	1/4-20 Dia.

Microsemi	Industry	Working Peak	Repetitive Peak
Catalog Number	Part Number	Reverse Voltage	Reverse Voltage

CPT60080* MBR60080CT 80V 80V CPT60090* 90V 90V CPT600100* MBR600100CT 100V 100V

*Add Suffix A for Common Anode, D for Doubler

- Schottky Barrier Rectifier
- Guard ring protection
- 600 Amperes/ 80 to 100 Volts
- 175°C junction temperature
- Reverse energy tested
- ROHS Compliant

Electrical Characteristics

Average forward current per pkg Average forward current per leg Maximum surge current per leg Maximum repetitive reverse current per leg ^IR(OV) 2 Amps
Max peak forward voltage per lea VFM 0.85 Volt Max peak forward voltage per leg Max peak forward voltage per leg Max peak reverse current per leg Max peak reverse current per leg

Typical junction capacitance per leg

(AV) 300 Amps IFSM 6000 Amps 0.85 Volts V_{FM} 0.62 Volts 75 mA ^IRM ^IRM 8.0 mA 9000 pF

[F(AV) 600 Amps

 ^{T}C = 132°C, Square wave, $^{R}\Theta JC$ = 0.10°C/W ^{T}C = 132°C, Square wave, $^{R}\Theta JC$ = 0.20°C/W 8.3ms, half sine, ^{T}J = 175°C

f = 1 KHZ, 25°C, 1µsec square wave |FM = 300A:TJ = 25°C |FM = 300A:TJ = 175°C

 $VRRM, TJ = 125^{\circ}C^{*}$ VRRM, TJ = 25°C $V_R = 5.0V, T_C = 25^{\circ}C$

*Pulse test: Pulse width 300 µsec, Duty cycle 2%

Thermal and Mechanical Characteristics

TSTG Storage temp range ΤJ Operating junction temp range R OJC Max thermal resistance per leg R OJC Max thermal resistance per pkg Recs Typical thermal resistance (greased) Terminal Torque Mounting Base Torque (outside holes) Mounting Base Torque (center hole) center hole must be torqued first Weight

-55℃ to 175℃ -55°C to 175°C 0.20°C/W Junction to case 0.10°C/W Junction to case 0.08°C/W Case to sink 35-40 inch pounds 30-40 inch pounds 8-10 inch pounds

2.8 ounces (78 grams) typical



CPT60080 - CPT600100

Figure 1 Typical Forward Characteristics — Per Leg

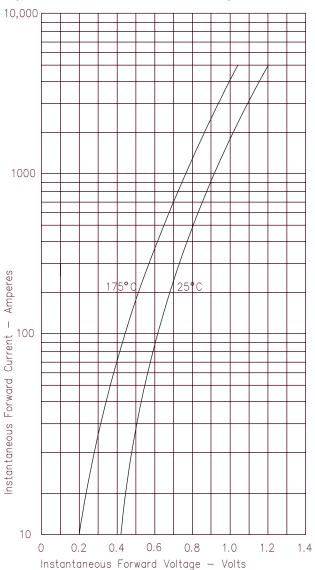


Figure 2 Typical Reverse Characteristics — Per Leg

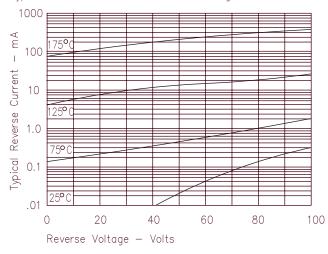


Figure 3 Typical Junction Capacitance — Per Leg

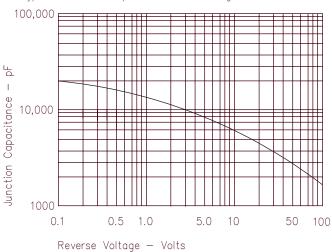
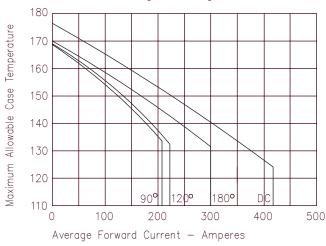
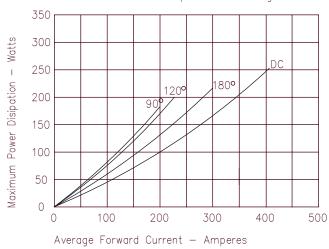


Figure 4
Forward Current Derating — Per Leg



Maximum Forward Power Dissipation — Per Leg





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